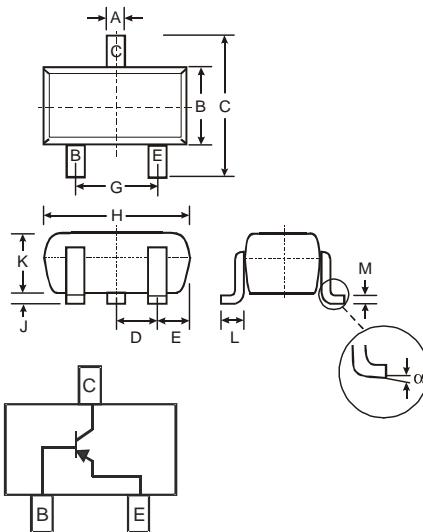


Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (MMST3904)
- Ultra-Small Surface Mount Package
- Lead Free/ROHS Compliant (Note 2)**
- "Green" Device (Notes 3 and 4)**

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Marking Information: K5N - See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.006 grams (approximate)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
α	0°	8°

All Dimensions in mm

Maximum Ratings

$\text{@ } T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-40	V
Collector-Emitter Voltage	V_{CEO}	-40	V
Emitter-Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous (Note 1)	I_C	-200	mA
Power Dissipation (Note 1)	P_d	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R_{JJA}	625	°C/W
Operating and Storage Temperature Range	T_j, T_{STG}	-55 to +150	°C

Notes:

1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
2. No purposefully added lead.
3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
4. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

Electrical Characteristics

$\text{@T}_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)					
Collector-Base Breakdown Voltage	$V_{(\text{BR})\text{CBO}}$	-40	—	V	$I_C = -10\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage	$V_{(\text{BR})\text{CEO}}$	-40	—	V	$I_C = -1.0\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(\text{BR})\text{EBO}}$	-5.0	—	V	$I_E = -10\mu\text{A}, I_C = 0$
Collector Cutoff Current	I_{CEX}	—	-50	nA	$V_{\text{CE}} = -30\text{V}, V_{\text{EB}(\text{OFF})} = -3.0\text{V}$
Base Cutoff Current	I_{BL}	—	-50	nA	$V_{\text{CE}} = -30\text{V}, V_{\text{EB}(\text{OFF})} = -3.0\text{V}$
ON CHARACTERISTICS (Note 5)					
DC Current Gain	h_{FE}	60	—	—	$I_C = -100\mu\text{A}, V_{\text{CE}} = -1.0\text{V}$
		80	—		$I_C = -1.0\text{mA}, V_{\text{CE}} = -1.0\text{V}$
		100	300		$I_C = -10\text{mA}, V_{\text{CE}} = -1.0\text{V}$
		60	—		$I_C = -50\text{mA}, V_{\text{CE}} = -1.0\text{V}$
		30	—		$I_C = -100\text{mA}, V_{\text{CE}} = -1.0\text{V}$
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{SAT})}$	—	-0.20 -0.30	V	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$
Base-Emitter Saturation Voltage	$V_{\text{BE}(\text{SAT})}$	-0.65 —	-0.85 -0.95	V	$I_C = -10\text{mA}, I_B = -1.0\text{mA}$ $I_C = -50\text{mA}, I_B = -5.0\text{mA}$
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C_{obo}	—	4.5	pF	$V_{\text{CB}} = -5.0\text{V}, f = 1.0\text{MHz}, I_E = 0$
Input Capacitance	C_{ibo}	—	10	pF	$V_{\text{EB}} = -0.5\text{V}, f = 1.0\text{MHz}, I_C = 0$
Input Impedance	h_{ie}	2.0	12	k Ω	$V_{\text{CE}} = 1.0\text{V}, I_C = 10\text{mA}, f = 1.0\text{kHz}$
Voltage Feedback Ratio	h_{re}	0.1	10	$\times 10^{-4}$	
Small Signal Current Gain	h_{fe}	100	400	—	
Output Admittance	h_{oe}	3.0	60	μS	
Current Gain-Bandwidth Product	f_T	300	—	MHz	$V_{\text{CE}} = -20\text{V}, I_C = -10\text{mA}, f = 100\text{MHz}$
Noise Figure	NF	—	4.0	dB	$V_{\text{CE}} = -5.0\text{V}, I_C = -100\mu\text{A}, R_S = 1.0\text{k}\Omega, f = 1.0\text{kHz}$
SWITCHING CHARACTERISTICS					
Delay Time	t_d	—	35	ns	$V_{\text{CC}} = -3.0\text{V}, I_C = -10\text{mA},$
Rise Time	t_r	—	35	ns	$V_{\text{BE}(\text{off})} = 0.5\text{V}, I_{B1} = -1.0\text{mA}$
Storage Time	t_s	—	225	ns	$V_{\text{CC}} = -3.0\text{V}, I_C = -10\text{mA},$
Fall Time	t_f	—	75	ns	$I_{B1} = I_{B2} = -1.0\text{mA}$

Note: 5. Short duration pulse test used to minimize self-heating effect.

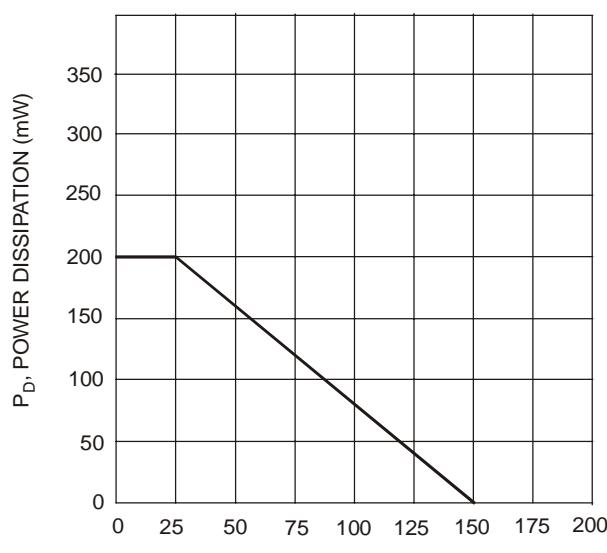


Fig. 1, Max Power Dissipation vs.
Ambient Temperature

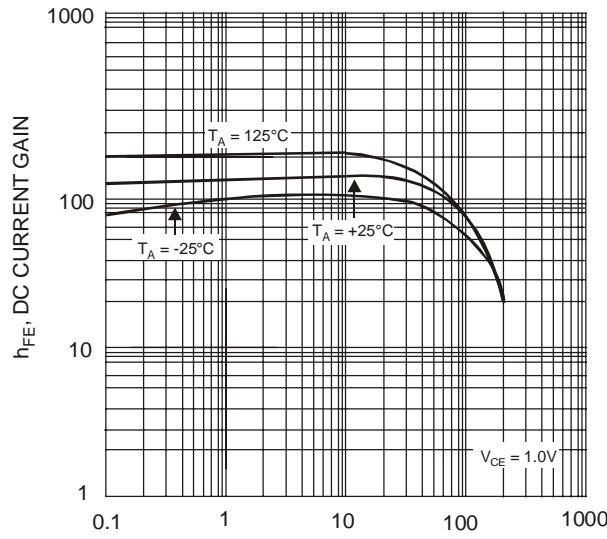


Fig. 3, Typical DC Current Gain vs
Collector Current

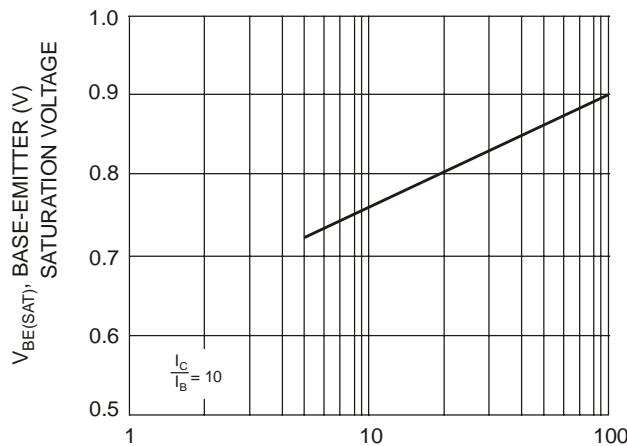


Fig. 5, Typical Base-Emitter
Saturation Voltage vs. Collector Current

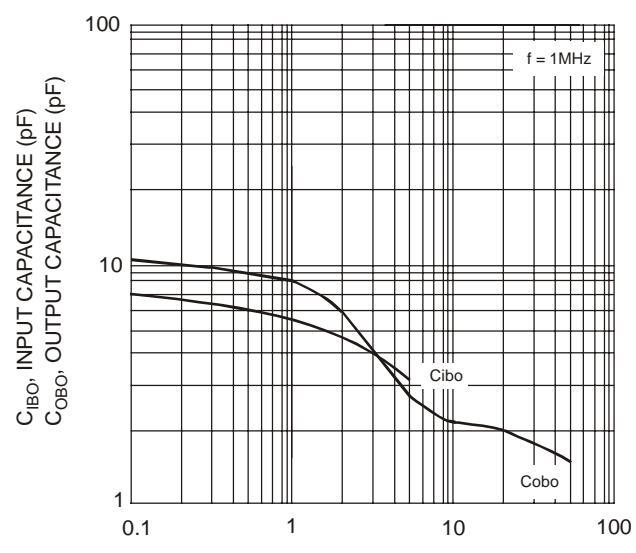


Fig. 2, Input and Output Capacitance vs.
Collector-Base Voltage

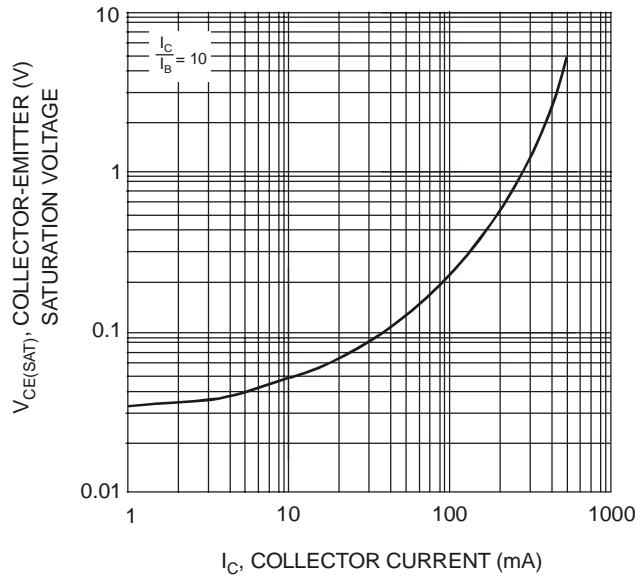


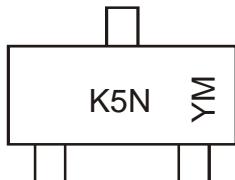
Fig. 4, Typical Collector-Emitter Saturation Voltage
vs. Collector Current

Ordering Information (Notes 4 and 6)

Device	Packaging	Shipping
MMST3906-7-F	SOT-323	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



K5N = Product Type Marking Code
 YM = Date Code Marking
 Y = Year ex: N = 2002
 M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	M	N	P	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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